

High-performance Video Signal Switchers

Video · Audio Signal Switchers for Car Navigation Car DVD Player





BH7649KS2 No.11066EAT05

Description

BH7649KS2 is built-in video switch, audio switch and isolation amplifier in a single chip.

Features

- 1) Video inputs selector: 7-inputs composite, Video outputs: 2-outputs 75Ω video driver, 2-outputs AMP
- 2) Built in Video gain switch (-6dB / -3dB / 0dB / 3dB)
- 3) Built in Video LPF switch (6.75MHz / Through)
- 4) Built in sag compensation circuit
- 5) Enables two load drivers
- 6) Video driver: Able to be used without load
- 7) Video driver: Able to be used without output coupling capacitor(one load)
- 8) Audio inputs selector: 5-inputs(Lch, Rch), Audio outputs: 2-outputs(Lch, Rch)
- 9) Built in Audio gain switch (0dB / -6dB)
- 10) Built in Audio LPF switch (24kHz / Through)
- 11) Built in MUTE function
- 12) Audio/Video all inputs: Built in isolator function
- 13) Selectable isolator function for different Audio/Video input channels
- 14) Serial control with I²C-BUS (I²C-BUS is compatible with fast mode of Version2.0)
- 15) Optional Slave address modifications (90H / 92H)

Applications

Car navigation, Car DVD

● Absolute maximum ratings (Ta=+25°C)

Parameter	Symbol	Ratings	Unit
Supply voltage VVcc	VVccmax	10	V
Supply voltage AVcc	AVccmax	10	V
Power dissipation	Pd	1900 *1	mW
Input voltage range I ² C-BUS input (SCL, SDA)	V _{I2CIN}	-0.2 ~ 7.0	V
Input voltage range Video selector, LOGIC (VIN1, VRET1, VIN2, VRET2, VIN3, VRET3, VIN4, VRET4, VIN5, VRET5, VIN6, VRET6, VIN7, VRET7, ADR)	V _{IN1}	-0.2 ~ 5.1	V
Input voltage range Video driver (VDIN1, VDIN2)	V_{DIN1}	-0.2 ~ VVcc+0.2	V
Input voltage range Audio seletor (LIN1, ARET1, RIN1, LIN2, ARET2, RIN2, LIN3, ARET3, RIN3, LIN4, ARET4, RIN4, LIN5, ARET5, RIN5)	V _{AIN1}	-0.2 ~ AVcc+0.2	V
Storage temperature range	Tstg	-55 ~ +125	°C

^{*1} When mounting on a 70mm×70mm×1.6mm 4-layer glass epoxy board Reduced by 19mW/°C at Ta = +25°C or higher

Operating conditions

Parameter	Symbol	Ratings	Unit
Supply voltage VVcc	VVcc	+7.5 ~ +9.5	V
Supply voltage AVcc	AVcc	+7.5 ~ +9.5	V
Operating temperature range	Topr	-40 ~ +85	°C

^{*} This product is not designed for protection against radioactive rays.

● Electric characteristic (Unless otherwise specified, Ta=+25°C, VVcc=8.5V, AVcc=8.5V)

-			· · ·	Limits		,		
	Parameter		Symbol	Min.	Тур.	Max.	Unit	Conditions
	Circuit current1		ICC1	-	34	48	mA	No signal(VIDEO)
CHIP	Circuit current2		ICC2	-	23	32	mA	No signal(AUDIO)
		-6dB	GVM6 _V	-6.4	-6.0	-5.6	dB	Vin=1.0Vpp, f=100kHz
		-3dB	GVM3 _V	-3.4	-3.0	-2.6	dB	Vin=1.0Vpp, f=100kHz
	Voltage gain 0dB		GV0 _√	-0.4	0.0	0.4	dB	Vin=1.0Vpp, f=100kHz
		3dB	GV3 _V	2.6	3.0	3.4	dB	Vin=1.0Vpp, f=100kHz
	6dB Frequency characteristics1 [f=6.75MHz LPF MODE]		GV6 _√	5.6	6.0	6.4	dB	Vin=1.0Vpp, f=100kHz
			GF11 _∨ GF12 _∨	-1.5 -	0.0 -30	1.0 -20	dB dB	Vin=1.0Vpp, f=6.75MHz/100kHz Vin=1.0Vpp, f=27MHz/100kHz
	Frequency charact	eristics 2_1	GF2 _V	-0.6	0.9	1.9	dB	Vin=1.0Vpp, f=10MHz/100kHz Gain=-6dB
	Frequency charact		GF2 _√	-0.7	0.8	1.8	dB	Vin=1.0Vpp, f=10MHz/100kHz Gain=-3dB
VIDEO	Frequency charact		GF2∨	-0.7	0.8	1.8	dB	Vin=1.0Vpp, f=10MHz/100kHz Gain=0dB
	Frequency charact	_3dB]	GF2 _√	-1.0	0.5	1.5	dB	Vin=1.0Vpp, f=10MHz/100kHz Gain=3dB
	Frequency charact [VDOUT1, VDOUT	eristics 3 2]	GF3 _∨	-3.0	-0.5	1.0	dB	Vin=1.0Vpp, f=15MHz
	Maximum output le	vel	VOM_V	2.6	-	-	Vp-p	f=10kHz, THD=1.0%
	Cross talk		CT _V	-	-60	-50	dB	Vin=1.0Vpp, f=4.43MHz
	MUTE attenuation		MT_V	-	-60	-50	dB	Vin=1.0Vpp, f=4.43MHz
	Common mode rej	ection ratio	CMRR	-	-60	-40	dB	Vin=1Vpp, f=20kHz
	Voltage goin	0dB	GV0 _A	-0.4	0.0	0.4	dB	Vin=1Vrms, f=1kHz
	Voltage gain	-6dB	GV6 _A	-6.4	-6.0	-5.6	dB	Vin=1Vrms, f=1kHz
	Frequency charact		GF11 _A	-2.0	-0.5	1.0	dB	Vin=1Vrms, f=24kHz/1kHz
	[f=24kHz LPF MOI		GF12 _A	-	-26	-15	dB	Vin=1Vrms, f=96kHz/1kHz
	Frequency charact [THROUGH MODE		GF2 _A	-1.0	0.0	1.0	dB	Vin=1Vrms, f=50kHz/1kHz
	Total harmonic dist	ortion	THD+N	-	0.002	0.1	%	Vin=1Vrms, f=1kHz ※1
	Maximum output le	vel	VOMA	2.0	2.4	-	Vrms	f=1kHz, THD<0.3% ※1
AUDIO	Cross talk		CTA	-	-100	-85	dB	Vin=2Vrms, f=1kHz ※1
	MUTE attenuation		MT_A	-	-100	-85	dB	Vin=2Vrms, f=1kHz ※1
	Residual noise1 [THROUGH MODE	 :]	N _A	-	10	-	uVrms	(THROUGH MODE select) *2
	Residual noise2 [f=24kHz LPF MOD	DE]	N _{A_LPF}	-	20	-	uVrms	LOUT1, ROUT1(LPF select) ※2
	Common mode rej	ection ratio	CMRR		-70	-40	dB	Vin=1Vrms, f=1kHz
	PSRR		PSRR _A	-	-50	-	dB	% 3
	[SCL,SDA]		1		1		ı	
	VIL ¾4		Vin1L	0	-	1.0	V	Low Level input voltage
	VIH ¾4		Vin1H	2.0	-	5.5	V	High Level input voltage
	Input bias current		IINI2C	-10	0	10	uA	
I ² C	SDA output voltage)	VoL	0	-	0.4	V	at 3.0mA sink current
	[ADR]				<u> </u>		<u> </u>	
	VIL		Vin2L	0	-	1.0	V	Low Level input voltage
	VIH		Vin2H	2.0	-	5.1	V	High Level input voltage %5
	Input impedance		ZIN _{ADR}	70	100	130	kΩ	Pull-Down Resister
※1 400 Ⅰ	HzHPE + 30kHzl PF ON		∠ ¶ADK	, 0	100	.00	IV JL	. a Down Roolotoi

^{%1 400}HzHPF + 30kHzLPF ON

^{※2} IHF-A Filter ON

³ Vin=0.3Vpp, f=100Hz at VCC, 30kHzLPF ON

^{**4 &}lt;| 2 C-BUS(SCL,SDA) SPEC> VIL:-0.5[V] \sim 0.3V_{DD}[V], VIH:0.7 V_{DD}[V] \sim V_{DD}+0.5 or 5.5[V] (V_{DD}:12C-BUS_Supply voltage) <BH7649KS2> Be sure to use as VIL:0.0[V] \sim 1.0[V], VIH:2.0[V] \sim 5.5[V]

^{%5} We recommend that it is connect ADR Pin to 38Pin(VREG Pin) when ADR Pin is used as "H".

●Block Diagram (Audio block)

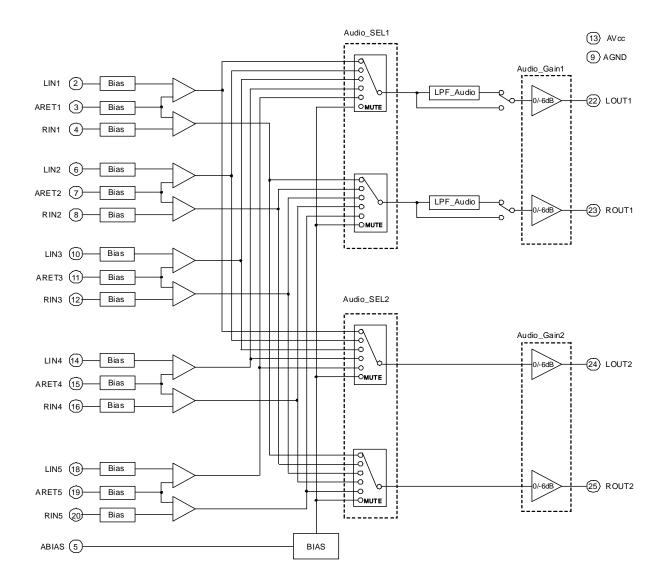


Fig.1 Block Diagram

● Block Diagram (Video block)

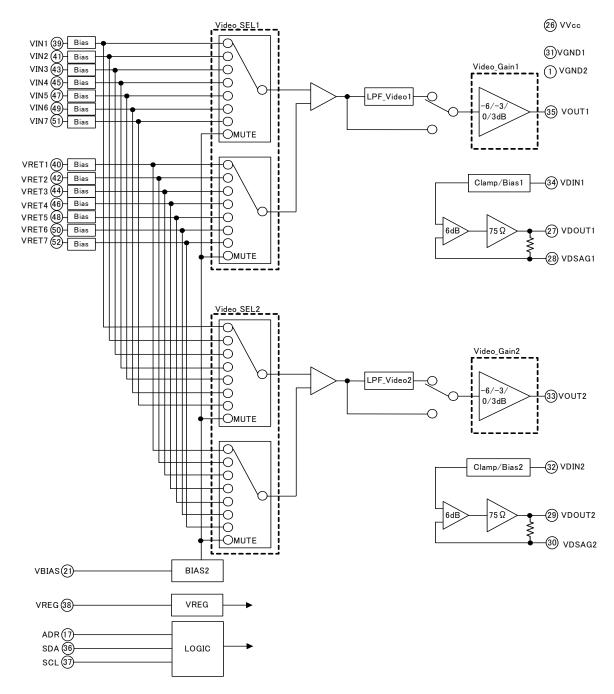


Fig.2 Block Diagram

●Package outlines

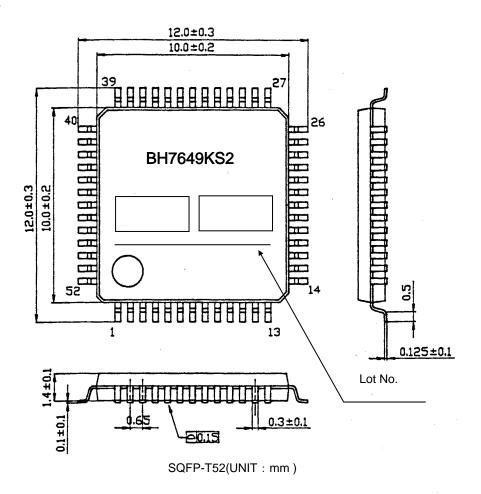


Fig.3 Package outlines

●Pin assignment table

No.	I/O	Pin Name									
1	-	VGND2	14	I	LIN4	27	0	VDOUT1	40	I	VRET1
2	I	LIN1	15	I	ARET4	28	0	VDSAG1	41	I	VIN2
3	I	ARET1	16	I	RIN4	29	0	VDOUT2	42	I	VRET2
4	I	RIN1	17	I	ADR	30	0	VDSAG2	43	I	VIN3
5	-	ABIAS	18	I	LIN5	31	-	VGND1	44	I	VRET3
6	I	LIN2	19	I	ARET5	32	I	VDIN2	45	I	VIN4
7	I	ARET2	20	I	RIN5	33	0	VOUT2	46	I	VRET4
8	I	RIN2	21	-	VBIAS	34	I	VDIN1	47	I	VIN5
9	-	AGND	22	0	LOUT1	35	0	VOUT1	48	I	VRET5
10	I	LIN3	23	0	ROUT1	36	I/O	SDA	49	I	VIN6
11	I	ARET3	24	0	LOUT2	37	I	SCL	50	I	VRET6
12	I	RIN3	25	0	ROUT2	38	0	VREG	51	I	VIN7
13	-	AVcc	26	-	VVcc	39	I	VIN1	52	I	VRET7

●I²C−BUS Control specification I²C-BUS Format (WRITE MODE)

S	SLAVE ADDRESS '	Α	DATA1	Α	DATA2	Α	DATA3	Α	DATA4	Α	DATA5	Α	DATA6	Α	Р	
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S : Start Condition Ā P : Acknowledge : Stop Condition

	b7	b6	b5	b4	b3	b2	b1	b0
SLAVE ADDRESS	1	0	0	1	0	0	ADR	0
DATA1	DATA1 Video_SEL1				Video_SEL2	LPF_Video1	LPF_Video2	
DATA2	Video_Gain1 Video_			_Gain2	Clamp/Bias1	Video_power -off1	Video_power -off2	
DATA3		Audio_SEL1			Audio_SEL2		0	LPF_Audio
DATA4	0	0	Audio_Gain1	Audio_Gain2	0	0	0	0
DATA5	Isolation_V1	Isolation_V2	Isolation_V3	Isolation_V4	Isolation_V5	Isolation_V6	Isolation_V7	0
DATA6	Isolation_A1	Isolation_A2	Isolation_A3	Isolation_A4	Isolation_A5	0	0	0

When power is turned on, all parts start from LOW condition.
[Prohibited matter] The terminal inputs of ADR do not change from start to stop condition. Operation error might happen.

Selecting input switch / Setting mode

Data name	Status	Data name	Status	Data name	Status
ADR	Sets the slave address by ADR pin	Clamp/Bias1	Input mode selectors (Clamp/Bias1 : VDIN1)	Isolation_V1	Isolator function selectors (VIN1)
	0 : 90H ADR pin = " L "		0 : Clamp input mode (VDOUT1:direct drive)		0 : On
	1 : 92H ADR pin =" H "		1 : Bias input mode (VDOUT1:output coupling "C")		1 : Off
Video_SEL1	Signal input selectors (Video_SEL1)	Clamp/Bias2	Input mode selectors (Clamp/Bias2 : VDIN2)	Isolation_V2	Isolator function selectors (VIN2)
	000 : VIN1		0 : Clamp input mode (VDOUT2 direct drive)		0 : On
	001 : VIN2		1 : Bias input mode (VDOUT2:output coupling "C")		1 : Off
	010 : VIN3	Video_power-off1	Power-off function selectors (VDIN1 - VDOUT1)	Isolation_V3	Isolator function selectors (VIN3
	011 : VIN4		0 : On		0 : On
	100 : VIN5		1 : Off		1 : Off
	101 : VIN6	Video_power-off2	Power-off function selectors (VDIN2 - VDOUT2)	Isolation_V4	Isolator function selectors (VIN4
	110 : VIN7		0 : On		0 : On
	111 : MUTE		1 : Off		1 : Off
Video_SEL2	Signal input selectors (Video_SEL2)	Audio_ SEL1	Signal input selectors (Audio_ SEL1)	Isolation_V5	Isolator function selectors (VIN5
	000 : VIN1		000 : LIN1, RIN1		0 : On
	001 : VIN2		001 : LIN2, RIN2		1 : Off
	010 : VIN3		010 : LIN3, RIN3	Isolation_V6	Isolator function selectors (VIN6
	011 : VIN4		011 : LIN4, RIN4		0 : On
	100 : VIN5		100 : LIN5, RIN5		1 : Off
	101 : VIN6		101 : MUTE	Isolation_V7	Isolator function selectors (VIN7
	110 : VIN7		110 : MUTE		0 : On
	111 : MUTE		111 : MUTE		1 : Off
LPF_Video1	LPF function selectors of VOUT1	Audio_ SEL2	Signal input selectors	Isolation_A1	Isolator function selectors (LIN1
	0 : 6.75MHz		(Audio_ SEL2) 000 : LIN1, RIN1		RIN1) 0 : On
	1 : Through		001 : LIN2, RIN2		1 : Off
LPF_Video2	LPF function selectors of VOUT2		010 : LIN3, RIN3	Isolation_A2	Isolator function selectors (LIN2
	0 : 6.75MHz		011 : LIN4, RIN4		RIN2) 0 : On
	1 : Through		100 : LIN5, RIN5		1 : Off
Video Gain1	Output gain selectors		101 : MUTE	Isolation_A3	Isolator function selectors (LIN3
	(Video_Gain1) 00 : -6dB		110 : MUTE		RIN3) 0 : On
	01 : -3dB		111 : MUTE		1 : Off
	10 : 0dB	LPF_Audio	LPF function selectors of LOUT1 and ROUT1	Isolation_A4	Isolator function selectors (LIN4 RIN4)
	11 : 3dB		0 : Through		0 : On
Video_Gain2	Output gain selectors		1 : 24kHz		1 : Off
	(Video_Gain2) 00 : -6dB	Audio_ Gain1	Output gain selectors (Audio_Gain1)	Isolation_A5	Isolator function selectors (LIN5 RIN5)
	01 : -3dB		0 : 0dB		0 : On
	10 : 0dB		1 : -6dB		1 : Off
	11 : 3dB	Audio_ Gain2	Output gain selectors (Audio_Gain2)		
			0 : 0dB		
			1 : -6dB		

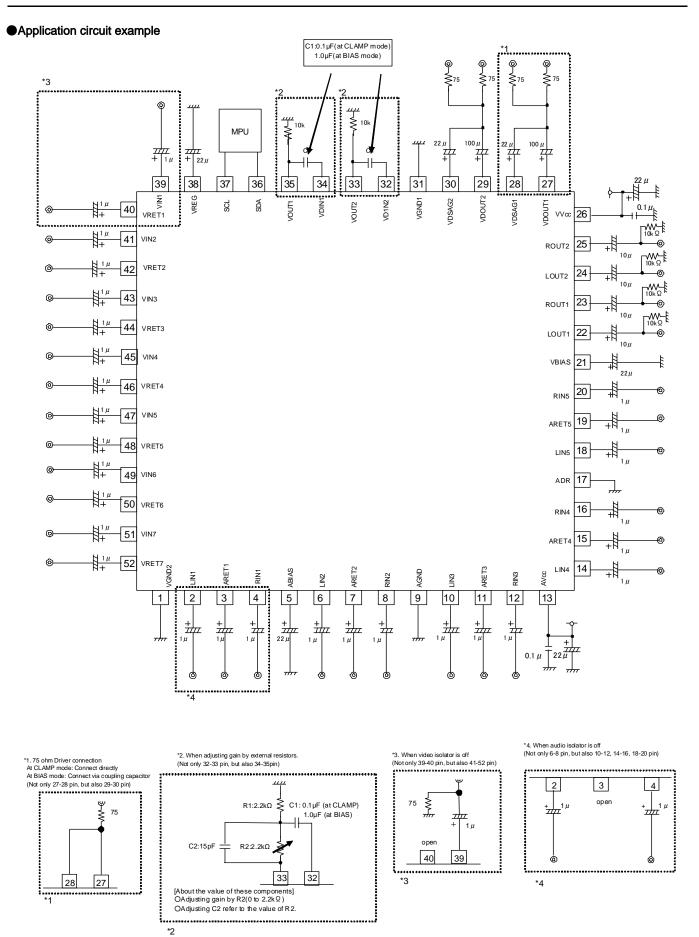


Fig.4

Evaluation board circuit diagram

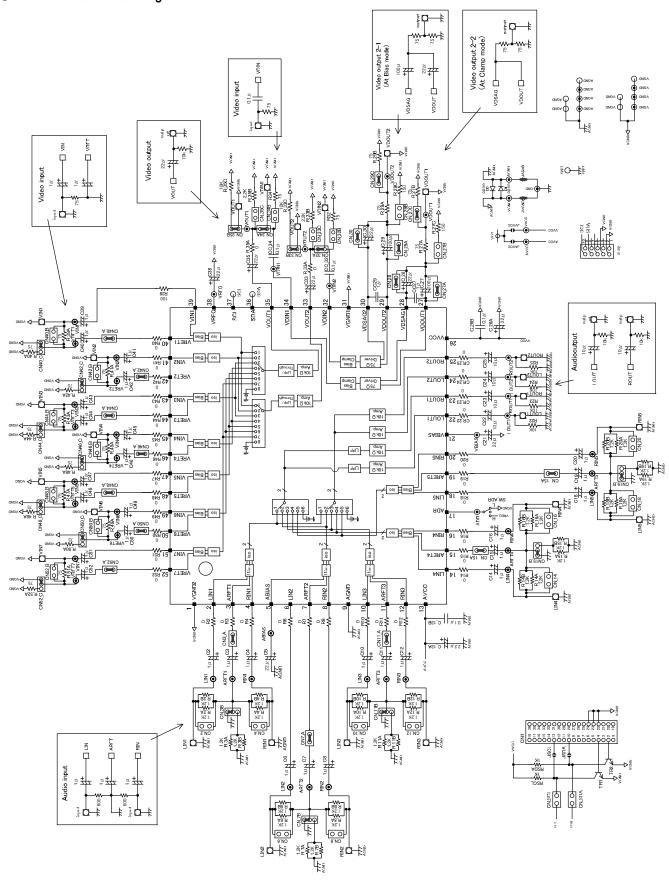
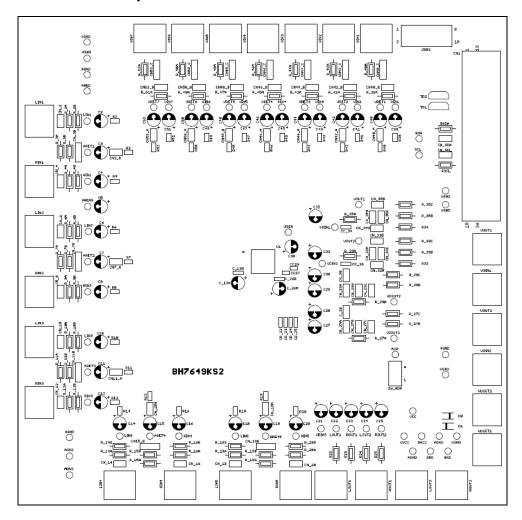
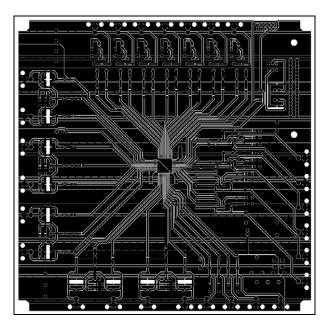


Fig.5

●Evaluation board PCB layer





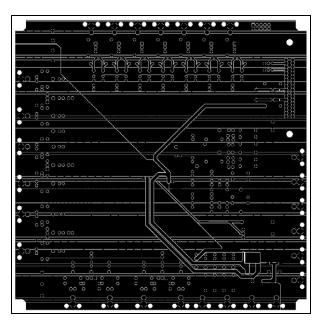


Fig.6

Notes for use

(1) Absolute maximum ratings

If the absolute maximum ratings for applied voltage and/or operation temperature are exceeded, LSI damage may result. Therefore, do not apply voltage or use in a temperature that exceeds these absolute maximum ratings. If it is possible that absolute maximum ratings will be exceeded, use a physical safety device such as a fuse and make sure that no conditions that might exceed the absolute maximum ratings will be applied to the LSI IC.

(2) GND potential

Regardless of the operation mode, the voltage of the GND pin should be at least the minimum voltage. Actually check whether or not the voltage at each pin, including transient phenomena, is less than the GND pin voltage.

(3) Thermal design

The thermal design should be done using an ample margin that takes into consideration the allowable dissipation under actual use conditions. Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.

(4) Shorts between pins and mounting errors

When mounting LSI ICs onto the circuit board, make sure each LSI's orientation and position is correct. The ICs may become damaged if they are not mounted correctly when the power is turned on. Similarly, damage may also result if a short occurs, such as when a foreign object is positioned between pins in an IC, or between a pin and power supply or GND connection.

(5) Operation in strong electromagnetic field

When used within a strong electromagnetic field, evaluate carefully to avoid the risk of operation faults.

(6) When not using a sag compensation circuit

Connect the sag compensation pin and output pin as closely as possible. There is a danger of high frequency oscillation. Also make the distance from the output pin (OUT pin, SAG pin) to the 75Ω resistance as short as possible.

(7) When using a sag compensation circuit

Make the length of the output pin (OUT pin, SAG pin) and capacitor as short as possible. There is a danger of high frequency oscillation. Also make the distance from the output pin (OUT pin, SAG pin) to the 75Ω resistance as short as possible. If these cautions is not observed in board layout, connect a capacitor $(0.01\mu\text{F}\sim0.1\mu\text{F})$ as short as possible

(8) VGND1(31pin), VGND2(1pin) and AGND(9pin) connection

When to float any one of GND pins(VGND1, VGND2 and AGND) during operation, the internal ESD protection diode Between VGND1, VGND2 and AGND may be damaged by large current surge. If the abnormal design like floating any one of GND pins is required, it is advisable to connect external diodes between GND pins. The connection detail of external diodes is illustrated in Fig.7.

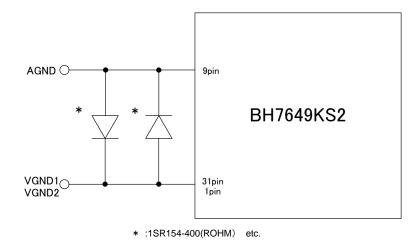
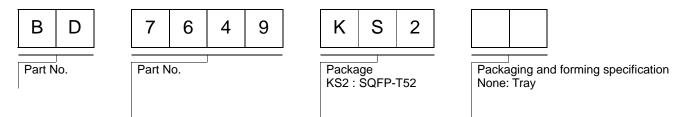
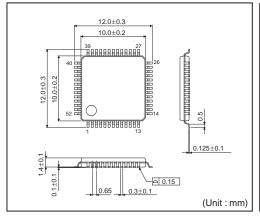


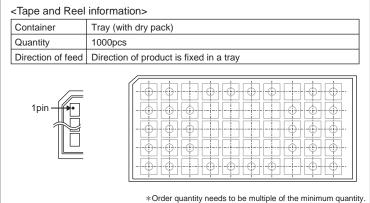
Fig.7 External diodes

Ordering part number



SQFP-T52





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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSIII	
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII	

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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